

SN5406, SN5416, SN7406, SN7416 HEX INVERTER BUFFERS/DRIVERS WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS

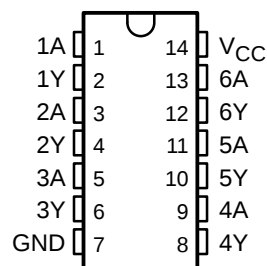
SDLS031A – DECEMBER 1983 – REVISED DECEMBER 2001

- Convert TTL Voltage Levels to MOS Levels
- High Sink-Current Capability
- Input Clamping Diodes Simplify System Design
- Open-Collector Drivers for Indicator Lamps and Relays
- Inputs Fully Compatible With Most TTL Circuits

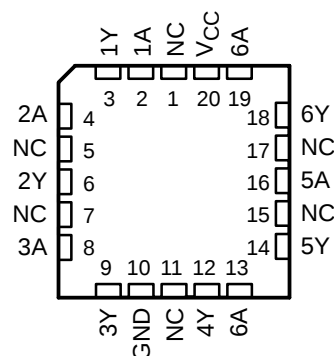
description

These TTL hex inverter buffers/drivers feature high-voltage open-collector outputs for interfacing with high-level circuits (such as MOS) or for driving high-current loads (such as lamps or relays), and also are characterized for use as inverter buffers for driving TTL inputs. The SN5406 and SN7406 have minimum breakdown voltages of 30 V. The SN5416 and SN7416 have minimum breakdown voltages of 15 V. The maximum sink current is 30 mA for the SN5406 and SN5416, and 40 mA for the SN7406 and SN7416.

SN5406, SN5416 . . . J OR W PACKAGE
SN7406 . . . D, N, OR NS PACKAGE
SN7416 . . . D OR N PACKAGE
(TOP VIEW)



SN5406 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

ORDERING INFORMATION

T _A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	SOIC – D	Tube	SN7406D	7406
		Tape and reel	SN7406DR	
		Tube	SN7416D	7416
		Tape and reel	SN7416DR	
	PDIP – N	Tube	SN7406N	SN7406N
			SN7416N	SN7416N
–55°C to 125°C	SOP – NS	Tape and reel	SN7406NSR	SN7406
	CDIP – J	Tube	SNJ5406J	SNJ5406J
		Tube	SNJ5416J	SNJ5416J
	CDIP – W	Tube	SNJ5406W	SNJ5406W
		Tube	SNJ5416W	SNJ5416W
	LCCC – FK	Tube	SNJ5406FK	SNJ5406FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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**TEXAS
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

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The diagram shows a 6-bit bus system. On the left, there are six input lines labeled 1A, 2A, 3A, 4A, 5A, and 6A. Each input line has a number next to it: 1, 3, 5, 9, 11, and 13 respectively. These lines pass through a series of inverters (triangles with a circle at the output). On the right, there are six output lines labeled 1Y, 2Y, 3Y, 4Y, 5Y, and 6Y. Each output line has a number next to it: 2, 4, 6, 8, 10, and 12 respectively. The output lines are connected to the input lines via a bus system. At the bottom left, there is a label $Y = \bar{A}$.

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SN5406, SN5416, SN7406, SN7416
HEX INVERTER BUFFERS/DRIVERS
WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS

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recommended operating conditions

			SN5406 SN5416			SN7406 SN7416			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage		2			2			V
V _{IL}	Low-level input voltage		0.8			0.8			V
V _{OH}	High-level output voltage	'06	30			30			V
		'16	15			15			
I _{OL}	Low-level output current		30			40			mA
T _A	Operating free-air temperature		−55			0			70 °C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†			SN5406 SN5416			SN7406 SN7416			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V _{IK}	V _{CC} = MIN, I _I = –12 mA			–1.5			–1.5			V
I _{OH}	V _{CC} = MIN, V _{IL} = 0.8 V, V _{OH} = §			0.25			0.25			mA
V _{OL}	V _{CC} = MIN, V _{IH} = 2 V		I _{OL} = 16 mA	0.4			0.4			V
			I _{OL} = ¶	0.7			0.7			
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1			mA
I _{IH}	V _{CC} = MAX, V _{IH} = 2.4 V			40			40			µA
I _{IL}	V _{CC} = MAX, V _{IL} = 0.4 V			–1.6			–1.6			mA
I _{CCH}	V _{CC} = MAX			30 48			30 48			mA
I _{CCL}	V _{CC} = MAX			32 51			32 51			mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ V_{OH} = 30 V for '06 and 15 V for '16.

¶ I_{OL} = 30 mA for SN54' and 40 mA for SN74'.

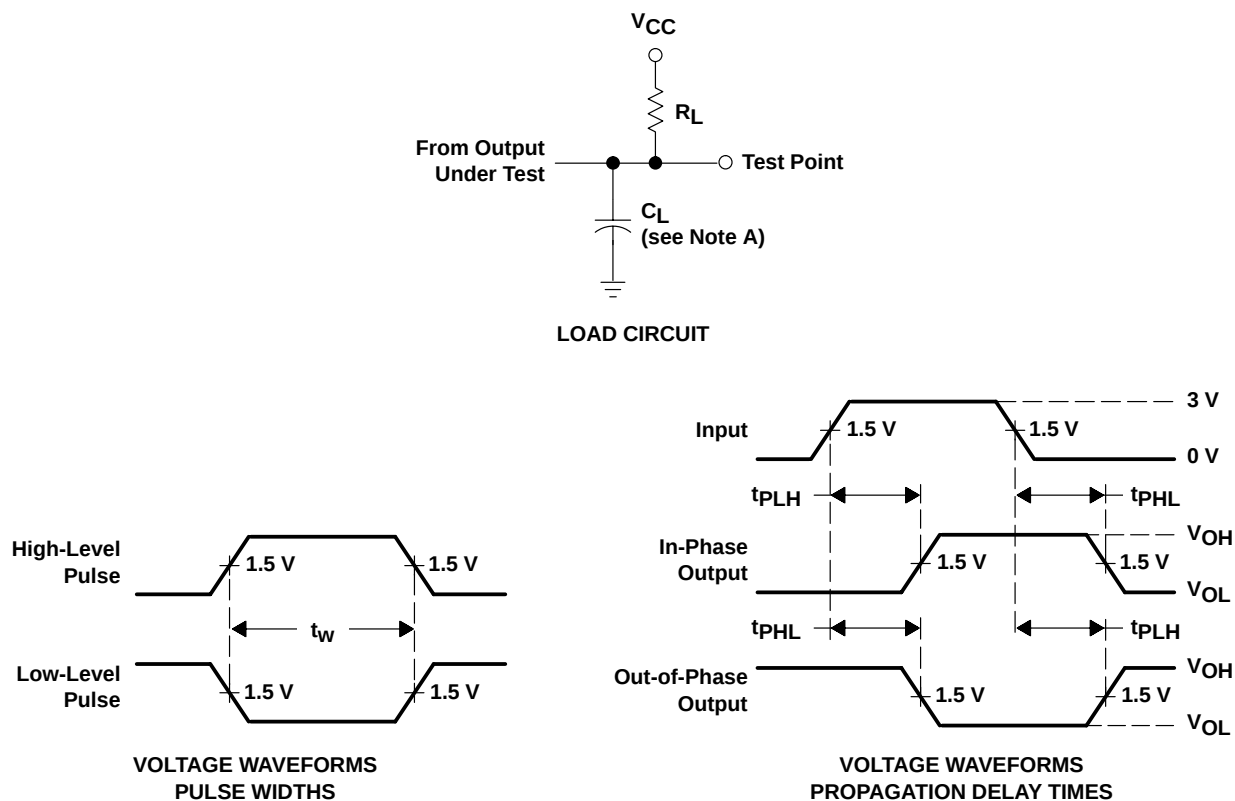
switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	A	Y	R _L = 110 Ω, C _L = 15 pF		10	15	ns
t _{PHL}					15	23	

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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
B. In the examples above, the phase relationships between inputs and outputs have been chosen arbitrarily.
C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1$ MHz, $Z_O = 50 \Omega$, $t_r \leq 7$ ns, $t_f \leq 7$ ns.
D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
JM38510/00801BCA	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
JM38510/00801BDA	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC
SN5406J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN5416J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN7406D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN7406DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN7406J	OBSOLETE	CDIP	J	14		None	Call TI	Call TI
SN7406N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN7406N3	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
SN7406NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN7416D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN7416DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN7416N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN7416N3	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
SN7416NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ5406FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ5406J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SNJ5406W	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC
SNJ5416J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SNJ5416W	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

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PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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